

2SK3142

Silicon N Channel MOS FET
High Speed Power Switching

HITACHI

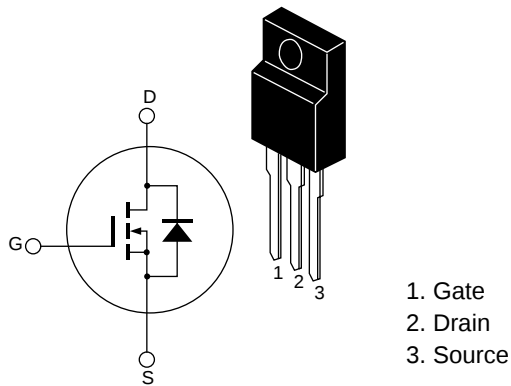
ADE-208-681A (Z)
2nd. Edition
Feb. 1999

Features

- Low on-resistance
 $R_{DS(on)} = 4m\Omega$ typ.
- Low drive current
- 4V gate drive device can be driven from 5V source

Outline

TO-220CFM



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	60	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	240	A
Body-drain diode reverse drain current	I_{DR}	60	A
Avalanche current	I_{AP} ^{Note 3}	35	A
Avalanche energy	E_{AR} ^{Note 3}	122	mJ
Channel dissipation	P_{ch} ^{Note 2}	35	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	−55 to +150	°C

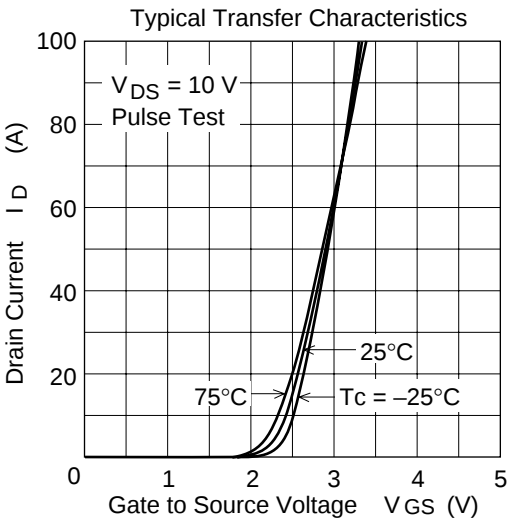
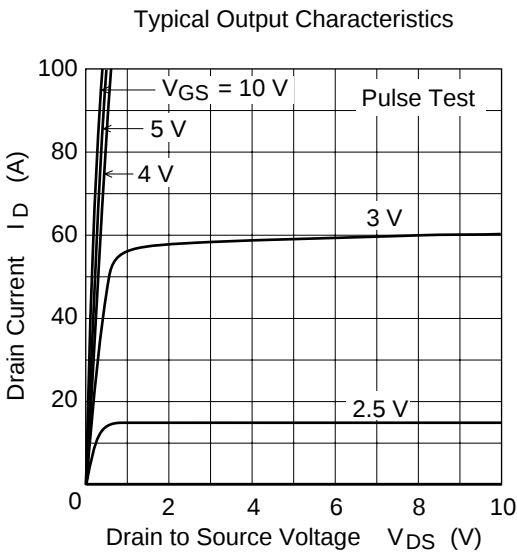
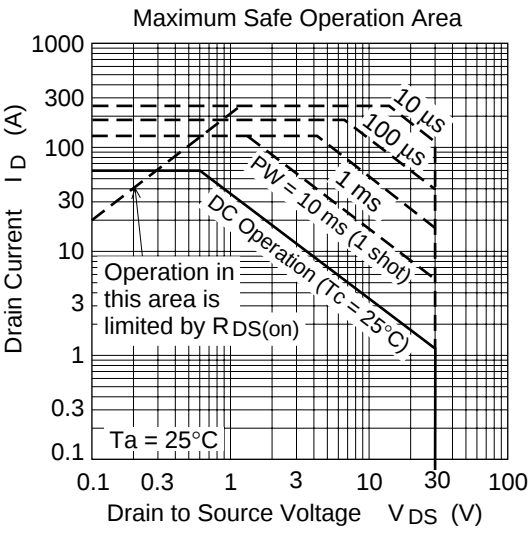
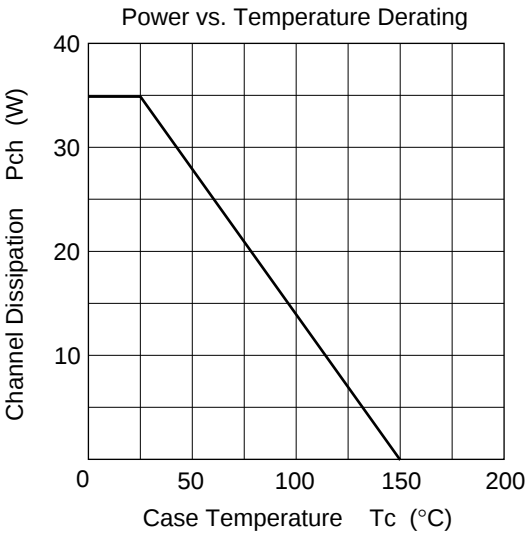
Note: 1. $PW \leq 10\mu s$, duty cycle $\leq 1\%$
2. Value at $T_c = 25^\circ C$
3. Value at $T_{ch} = 25^\circ C$, $R_g \geq 50\Omega$

Electrical Characteristics (Ta = 25°C)

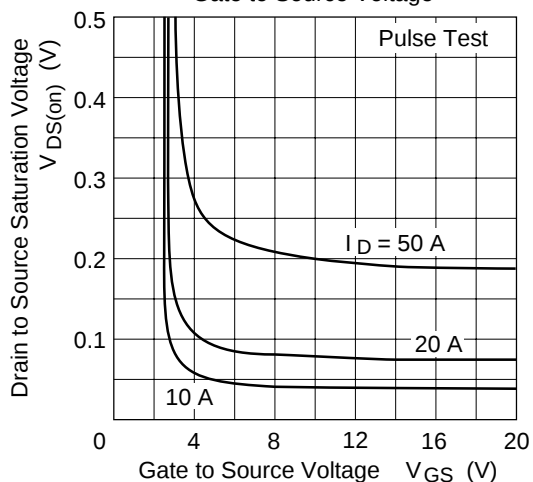
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10\text{mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 30\text{V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.5	V	$I_D = 1\text{mA}$, $V_{DS} = 10\text{V}$ ^{Note 1}
Static drain to source on state resistance	$R_{DS(on)}$	—	4.0	5.0	$\text{m}\Omega$	$I_D = 30\text{A}$, $V_{GS} = 10\text{V}$ ^{Note 1}
		—	5.5	8.5	$\text{m}\Omega$	$I_D = 30\text{A}$, $V_{GS} = 4\text{V}$ ^{Note 1}
Forward transfer admittance	$ y_{fs} $	45	75	—	S	$I_D = 30\text{A}$, $V_{DS} = 10\text{V}$ ^{Note 1}
Input capacitance	C_{iss}	—	6800	—	pF	$V_{DS} = 10\text{V}$
Output capacitance	C_{oss}	—	1550	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	500	—	pF	$f = 1\text{MHz}$
Total gate charge	Q_g	—	130	—	nc	$V_{DD} = 10\text{V}$
Gate to source charge	Q_{gs}	—	16	—	nc	$V_{GS} = 10\text{V}$
Gate to drain charge	Q_{gd}	—	30	—	nc	$I_D = 60\text{A}$
Turn-on delay time	$t_{d(on)}$	—	50	—	ns	$V_{GS} = 10\text{V}$, $I_D = 30\text{A}$
Rise time	t_r	—	340	—	ns	$R_L = 0.33\Omega$
Turn-off delay time	$t_{d(off)}$	—	560	—	ns	
Fall time	t_f	—	350	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.0	—	V	$I_F = 60\text{A}$, $V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	70	—	ns	$I_F = 60\text{A}$, $V_{GS} = 0$ $di_F/dt = 50\text{A}/\mu\text{s}$

Note: 1. Pulse test

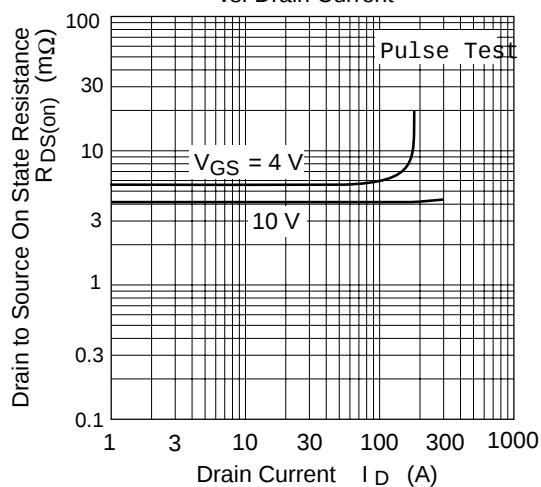
Main Characteristics



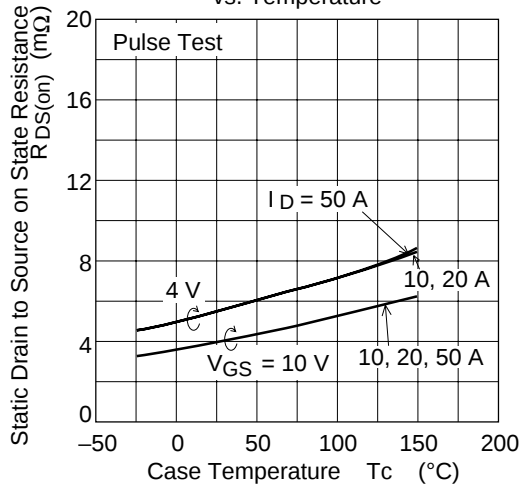
Drain to Source Saturation Voltage vs.
Gate to Source Voltage



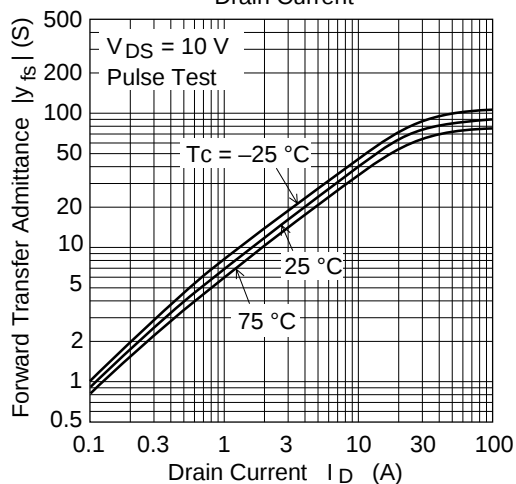
Static Drain to Source on State Resistance
vs. Drain Current



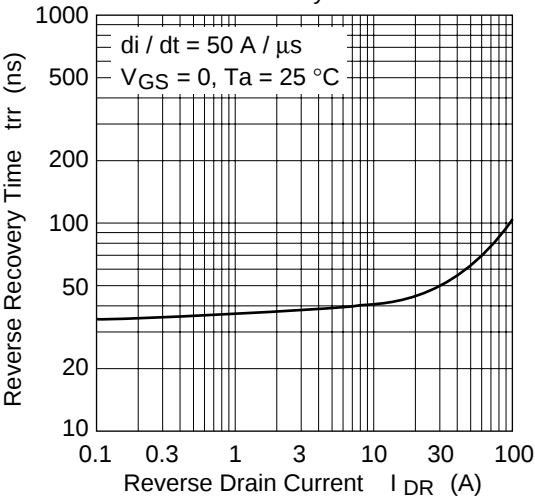
Static Drain to Source on State Resistance
vs. Temperature



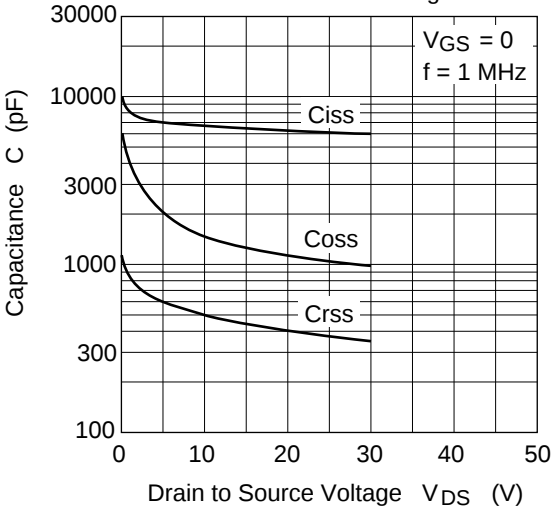
Forward Transfer Admittance vs.
Drain Current



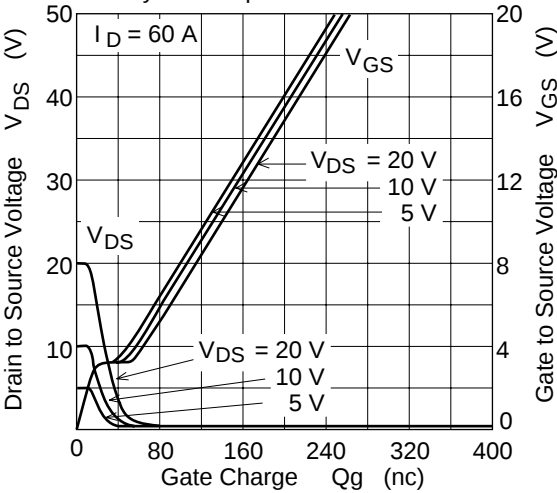
Body-Drain Diode Reverse Recovery Time



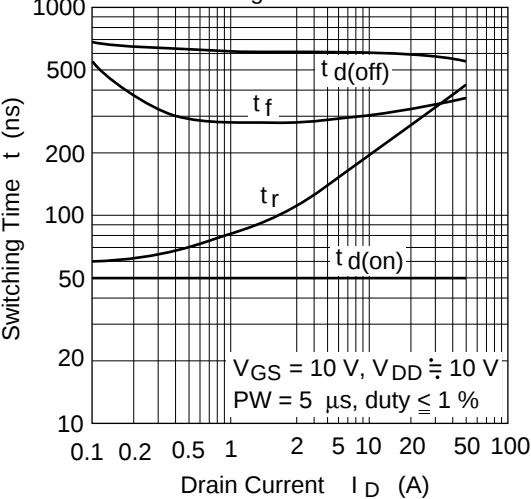
Typical Capacitance vs. Drain to Source Voltage

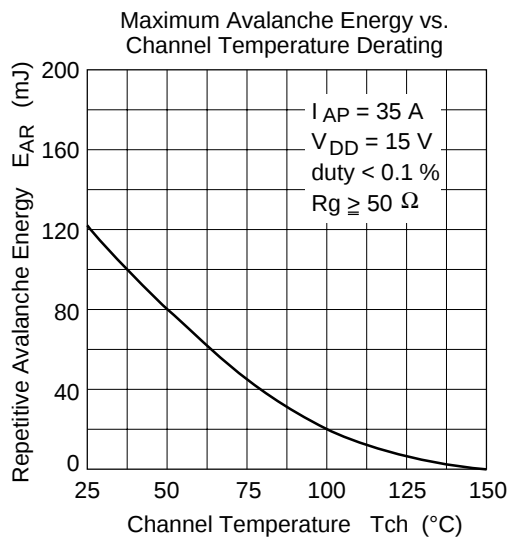
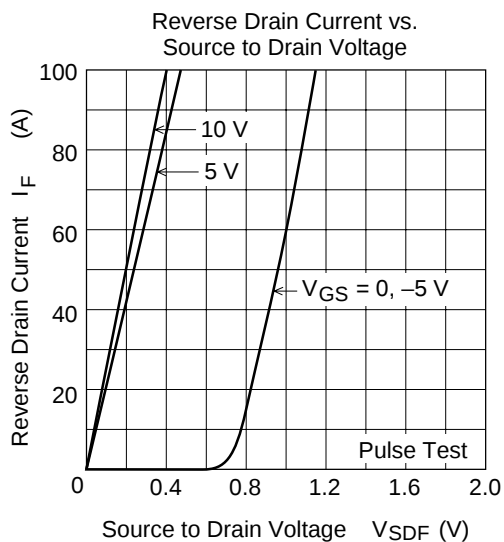


Dynamic Input Characteristics

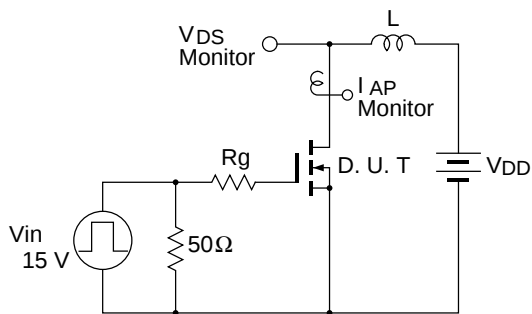


Switching Characteristics



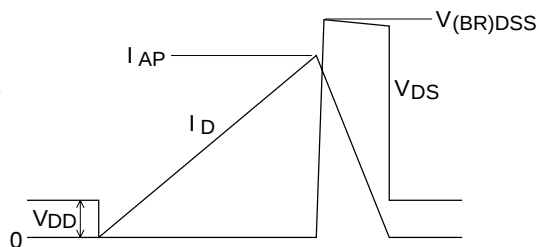


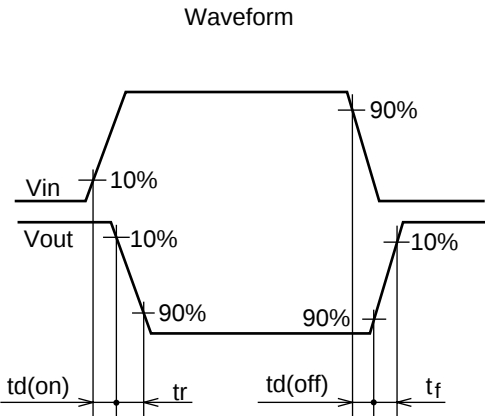
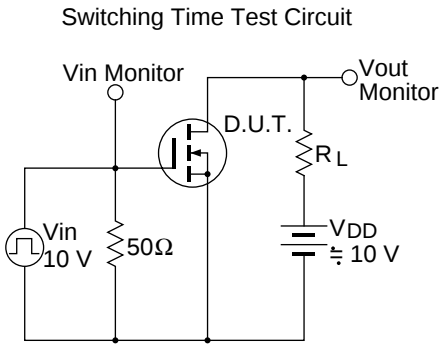
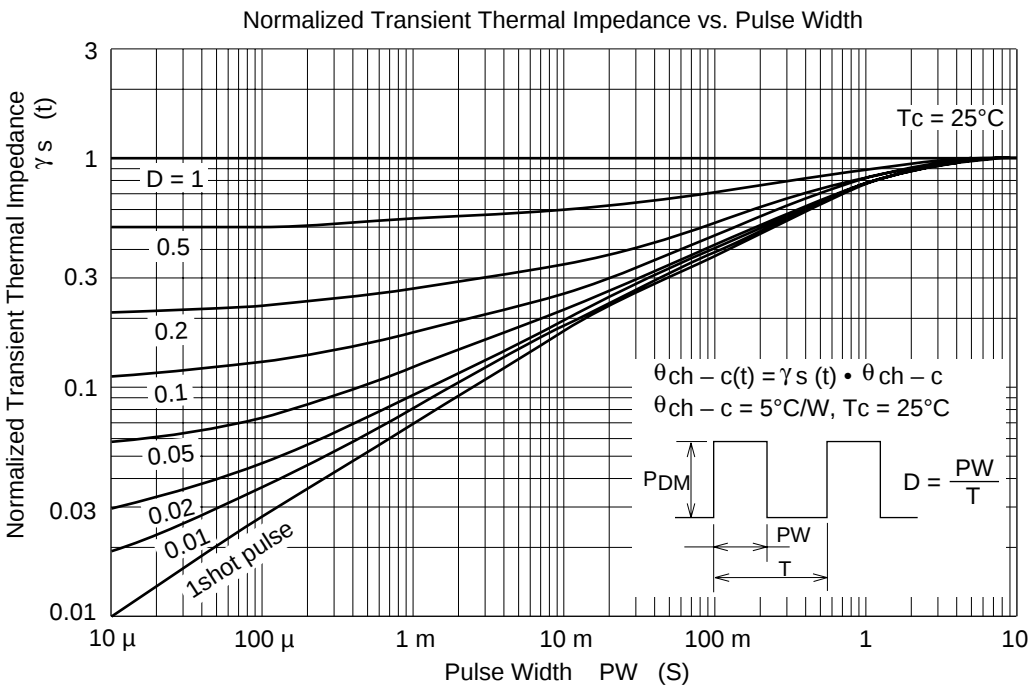
Avalanche Test Circuit



Avalanche Waveform

$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$

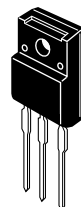
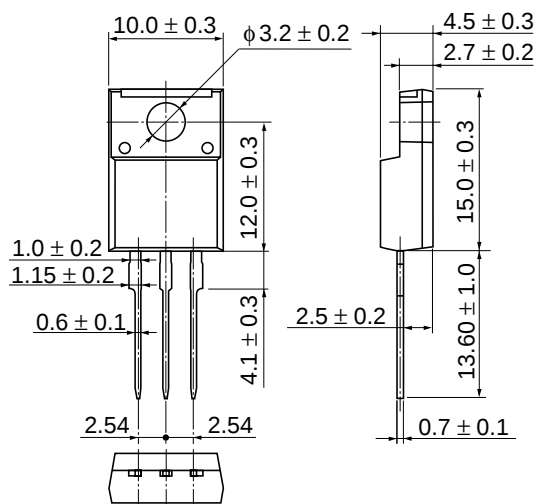




Package Dimensions

As of January, 2001

Unit: mm



Hitachi Code	TO-220CFM
JEDEC	—
EIAJ	—
Mass (reference value)	1.9 g

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